

11. The primer composition according to Claim 6 or 7
comprising a hydrosilylation catalyst as (F) component.

12. The primer composition according to Claim 6 or 7
comprising an organic solvent as (G) component.

16. The bonding method according to Claim 13 or 14
wherein said curable composition has a curing agent containing two or more silicon-
bound hydrogen atoms per molecule.

18. The bonding method according to Claim 13 or 14
wherein said primer composition comprises a polyvalent alkoxysilane and/or a
condensation product thereof as (C) component.

19. The bonding method according to Claim 13 or 14
wherein said primer composition comprises an organoaluminum compound and/or
an organotitanium compound as (D) component.

20. The bonding method according to Claim 13 or 14
wherein said primer composition comprises a hydrosilylation catalyst as (F)
component.

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21. The bonding method according to Claim 13 or 14
wherein said primer composition comprises an organic solvent as (G) component.

22. A laminate as obtainable by the bonding method according to Claim 13 or 14.

AS

27. The bonding method according to Claim 23 or 24
wherein said primer composition comprises a hydrosilylation catalyst as (F)
component.

28. The bonding method according to Claim 23 or 24
wherein said primer composition comprises an organic solvent as (G) component.

29. A laminate as obtainable by the bonding method according to Claim 23 or 24.

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